

PULSED MICROWAVE POWER TRANSISTOR

NPN silicon power transistor intended for use in military and professional applications. It operates only in pulsed conditions and is recommended for IFF applications at 1.09 GHz.

It offers the following technological advantages:

- Interdigitated structure giving a high emitter efficiency
- Diffused emitter ballasting resistors providing excellent current sharing and withstanding a high VSWR.
- Gold metallization realizes very good stability of the characteristics and excellent life time
- Multicell geometry gives good balance of dissipated power and thermal resistance

The transistor has an FO-67 metal ceramic flange package.

It is mounted in a common-base configuration, specified in class-C and operates in pulsed conditions. An input matching cell improves the input impedance and allows an easier design of wideband circuits.

QUICK REFERENCE DATA

Microwave performance up to $T_{mb} = 25^{\circ}\text{C}$ in a common-base class-C selective amplifier.

mode of operation	f GHz	V _{CC} V	P _L W	G _p dB	η_c %	z _i Ω	Z _L Ω
pulsed: t _p = 10 μ s δ = 1%	1.09	50	> 175	> 7.5	> 35	see Figs 3 and 4	

MECHANICAL DATA

FO-67 (see Fig.1)

WARNING

Product and environmental safety – toxic materials

This product contains beryllium oxide. The product is entirely safe provided that the BeO slab is not damaged. All persons who handle, use or dispose of this product should be aware of its nature and of the necessary safety precautions.

After use, dispose of as chemical or special waste according to the regulations applying at the location of the user. It must never be thrown out with general industrial or domestic waste.

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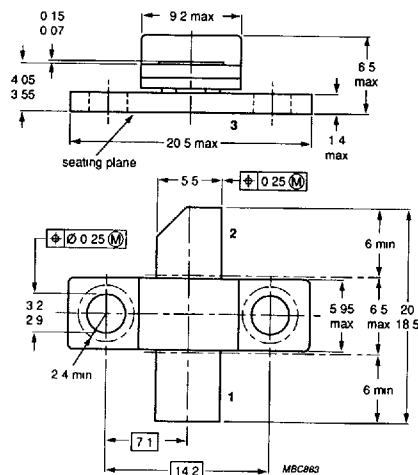
MECHANICAL DATA

Dimensions in mm

Fig. 1 FO-67.

Pinning:

1 = collector
2 = emitter
3 = base



Marking code

11175Y

Torque on screw: max. 0.4 Nm
Recommended screw: M2.5

RATINGS

Limiting values in accordance with the Absolute Maximum System (IEC 134)

Collector-base voltage, open emitter	V_{CBO}	max.	65 V
Collector-emitter voltage	V_{CES}	max.	65 V
$R_{BE} = 0$ open base	V_{CEO}	max.	25 V
Emitter-base voltage, open collector	V_{EBO}	max.	3.0 V
Collector current	I_C	max.	12.5 A
$t_p \leq 10 \mu s, \delta \leq 1\%$			
Total power dissipation	P_{tot}	max.	500 W
$t_p \leq 10 \mu s, \delta \leq 1\%; T_{mb} \leq 75^\circ C$			
Storage temperature	T_{stg}		-65 to 150 °C
Junction temperature	T_j	max.	200 °C
Soldering temperature	T_{sld}	max.	235 °C
at 0.1 mm from case; $t_{sld} \leq 10 s$			

THERMAL RESISTANCE (at $T_j = 75^\circ C$)

From junction to mounting base under pulsed conditions:

$t_p \leq 10 \mu s, \delta \leq 1\%$	$R_{th j-mb}$	max.	0.08 K/W
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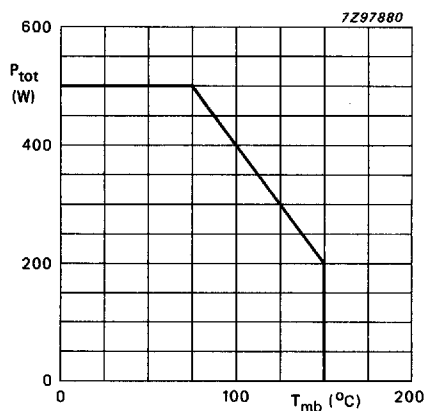


Fig. 2 Power derating curve as a function of mounting base temperature in pulsed condition.

CHARACTERISTICS $T_{mb} = 25^{\circ}\text{C}$ unless otherwise specified

Breakdown voltages

 $I_C = 40\text{ mA}; I_E = 0$ $V_{(BR)CBO}$ min. 65 V $I_C = 40\text{ mA}; R_{BE} = 0$ $V_{(BR)CES}$ min. 65 V

Collector cut-off current

 $I_E = 0; V_{CB} = 50\text{ V}$ I_{CBO} max. 15 mA

Emitter cut-off current

 $I_C = 0; V_{EB} = 1.5\text{ V}$ I_{EBO} max. 1.5 mA

Collector-base capacitance

 $I_E = I_C = 0; V_{CB} = 50\text{ V}$ C_{cb} typ. 45 pF

APPLICATION INFORMATION

Microwave performance up to $T_{mb} = 25^\circ\text{C}$ in a common-base class-B selective amplifier.

mode of operation	f GHz	V_{CC} V	P_L W	G_p dB	η_c %	z_i Ω	Z_L Ω
pulsed: $t_p = 10\ \mu\text{s}$ $\delta = 1\%$	1.09	50	≥ 175 typ. 200	≥ 7.5 typ. 8.5	≥ 35 typ. 40	see Figs 3 and 4	

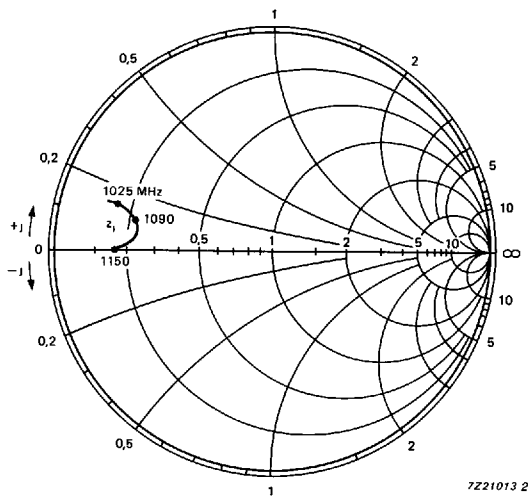


Fig.3 Input impedance as a function of frequency; $Z_0 = 50\ \Omega$; typical values.

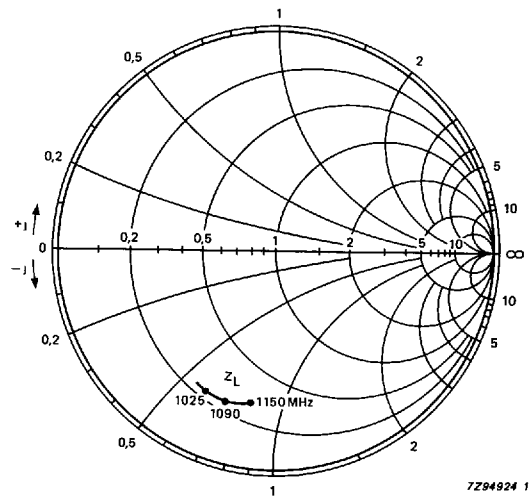


Fig.4 Optimum load impedance as a function of frequency; $Z_0 = 5\ \Omega$; typical values.